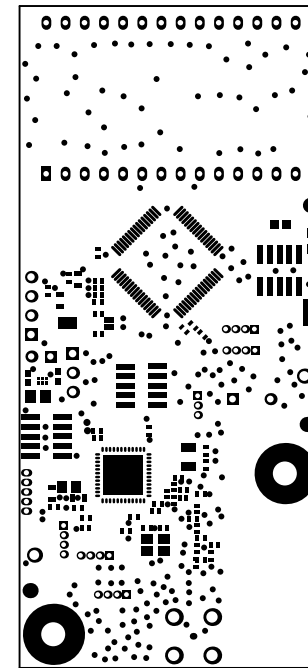
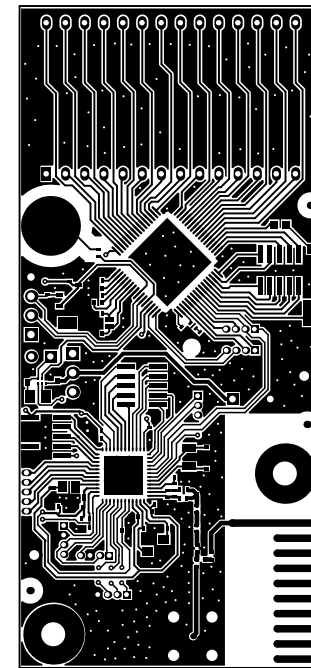


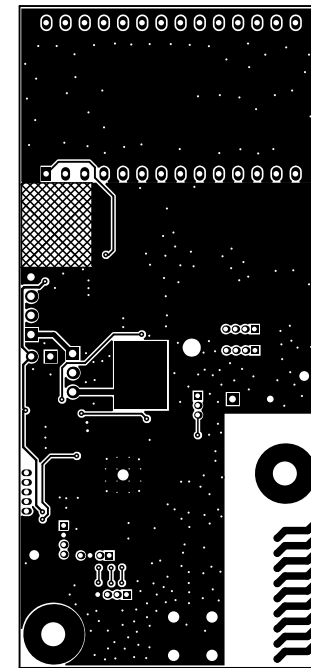
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00646	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: TIDA-00646		
PLOT NAME = Top Overlay	GENERATED : 10/23/2015 2:06:10 PM	TEXAS INSTRUMENTS	



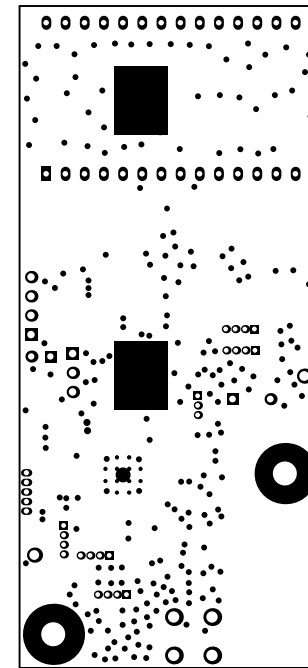
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00646	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: TIDA-00646		
PLOT NAME = Top Solder Mask	GENERATED : 10/23/2015 2:06:39 PM	TEXAS INSTRUMENTS	



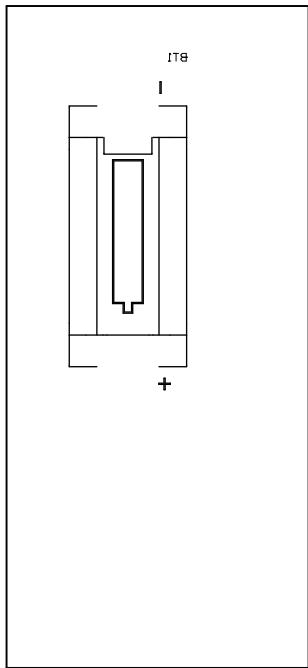
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00646	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: TIDA-00646		
PLOT NAME = Top Layer	GENERATED : 10/23/2015 2:07:08 PM		TEXAS INSTRUMENTS



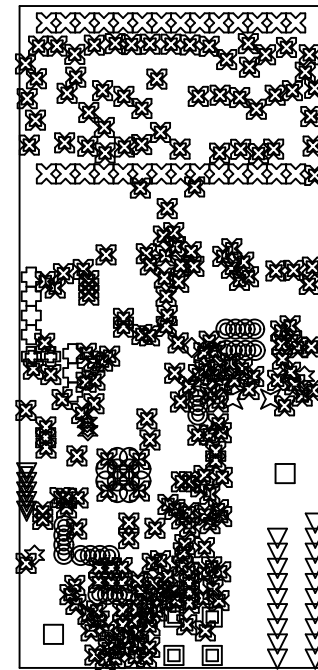
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00646	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: TIDA-00646		
PLOT NAME = Bottom Layer	GENERATED : 10/23/2015 2:07:37 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00646	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: TIDA-00646		
PLOT NAME = Bottom Solder Mask	GENERATED : 10/23/2015 2:08:05 PM	TEXAS INSTRUMENTS	

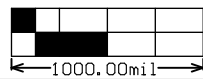
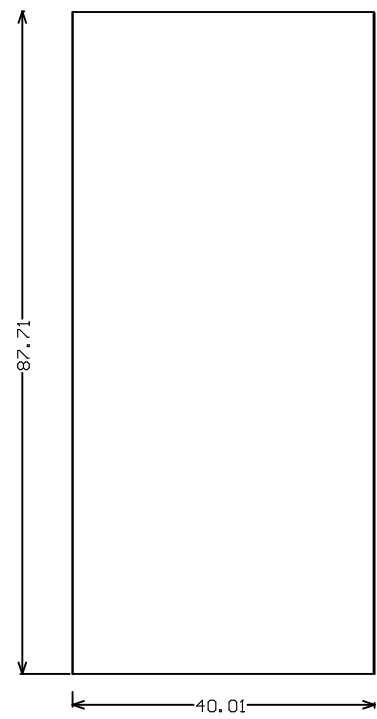


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00646	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: TIDA-00646		
PLOT NAME = Bottom Overlay	GENERATED : 10/23/2015 2:08:35 PM		TEXAS INSTRUMENTS



Symbol	Quantity	Finished Hole Size	Plated	Hole Type
◇	1	78.50mil (1.994mm)	NPTH	Round
○	12	7.87mil (0.200mm)	PTH	Round
✕	238	12.00mil (0.305mm)	PTH	Round
▽	19	14.96mil (0.380mm)	PTH	Round
✱	2	16.00mil (0.406mm)	PTH	Round
●	23	25.59mil (0.650mm)	PTH	Round
▼	5	27.56mil (0.700mm)	PTH	Round
⊗	28	29.53mil (0.750mm)	PTH	Round
⊙	2	33.46mil (0.850mm)	PTH	Round
⊗	2	35.43mil (0.900mm)	PTH	Round
⊙	7	40.00mil (1.016mm)	PTH	Round
⊗	2	52.00mil (1.321mm)	PTH	Round
■	5	59.06mil (1.500mm)	PTH	Round
□	2	125.98mil (3.200mm)	PTH	Round
	348 Total			

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00646	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: TIDA-00646		
PLOT NAME = Drill Drawing	GENERATED : 10/23/2015 2:09:05 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00646	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: TIDA-00646		
PLOT NAME = Board Dimensions	GENERATED : 10/23/2015 2:09:35 PM	TEXAS INSTRUMENTS	

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